



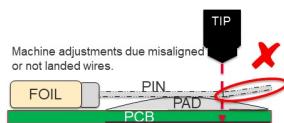
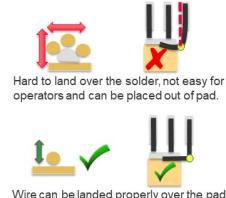
Product Change Notification (PCN)

PCN Number	508935	Date Issued	October 22, 2020
Reason for Change	Manufacturing Process Change (Molex)		
Change Type Description	This letter is to inform you that the manufacturing process for the part(s) identified in this notice is changing. No changes will be made to the product as a result of this process change.		
Reason for Short Notice	Custom Products		
Assessment of Change	Test report/Specification Test Report		
Internal Molex Qualification Date	June 30, 2020		
Sample Availability Date (Changed Part)	June 30, 2020		
Planned Implementation Date	November 16, 2020		
Method of Identifying Change	No special marking on the product or packaging		

Before Change

After Change

The current process includes a solder deposit over the pad, this deposit difficult the alignment during the process, once that the pads is bare the alignment will be easy to perform. This difference at the pin height needs to be adjusted at the machine (Variation at SMT Process)



Overview

- The purpose of this change is to reduce the quality defective and Reduce Variation at the Auto Solder Process for zQSFP products 30 AWG.
 - Product Impact
 - No impact to fit, form or function
 - Part Number Impact
 - See attached impacted parts list
 - Qualification Reports and samples available upon request after the date shown above



Product Change Notification (PCN)

You may address any technical inquiries regarding this PCN by sending E-mail to pcn_coordinator@molex.com or your Local Sales Engineer.

Note: While responding, please retain "**PCN Notification:508935**" in the e-mail Subject line for faster response.

RELEASED

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